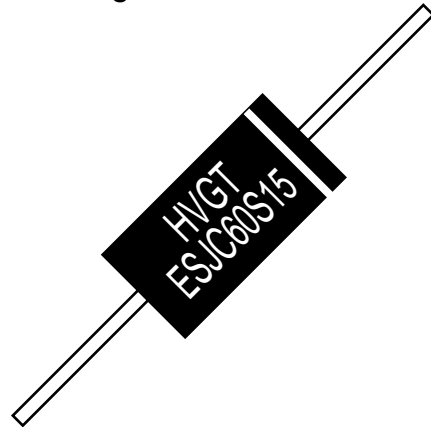


High reliability resin molded type high voltage diode in small size package which is sealed a multilayered mesa type silicon chip by epoxy resin.

■ Outline Drawings :



■ Features

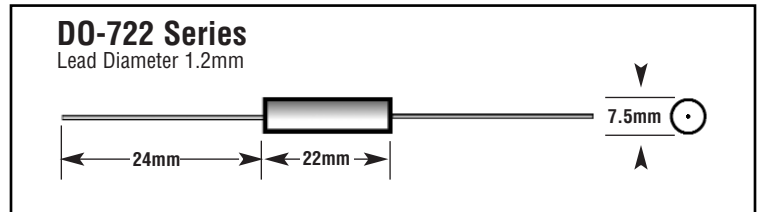
- High speed switching
- Epoxy resin molded in vacuum, Have anticorrosion in the surface
- High surge resistivity for CRT discharge
- High reliability design
- Avalanche characteristic

■ Applications

- X light Power supply
- Laser
- Voltage doubler circuit
- Microwave emission power
- General purpose high voltage rectifier, Voltage multiplier assembly.

■ Maximum Ratings and Characteristics

- Absolute Maximum Ratings



Items	Symbols	Condition	ESJC60S15	Units
Repetitive Peak Reverse Voltage	V_{RRM}	$T_a=25^{\circ}\text{C}$, $I_R = 0.1\text{mA}$	15	kV
Average Output Current	I_o	$T_a=25^{\circ}\text{C}$, Resistive Load	0.5	A _{peak}
Surge Current	I_{FSM}	$T_a=25^{\circ}\text{C}$, 8.3msec, half sine	30	A _{peak}
Junction Temperature	T_j		125	$^{\circ}\text{C}$
Allowable Operation Case Temperature	T_c		125	$^{\circ}\text{C}$
Storage Temperature	T_{stg}		-40 to +125	$^{\circ}\text{C}$

- Electrical Characteristics ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

Items	Symbols	Conditions	ESJC60S15	Units
Maximum Forward Voltage Drop	V_F	at 25°C , at: I_F	16	V
Maximum Reverse Current	I_{R1}	at 25°C , $V_R = V_{RRM}$	5.0	μA
	I_{R2}	at 100°C , $V_R = V_{RRM}$	50	μA
Maximum Reverse Recovery Time	T_{rr}	at 25°C ; $I_F = 0.5I_R$; $I_R = I_F(AV)$; $I_{rr} = 0.25I_R$	--	nS
Junction Capacitance	C_j	at 25°C ; $V_R = 0\text{V}$, $f = 1\text{MHz}$	--	pF